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MEMORY READING DEVICE

The present invention relates to a device for reading a memory and more specifically a read-only memory (ROM, PROM, EPROM, EEPROM).

Fig. 1 schematically and partially shows a ROM 2 including a plurality of memory points arranged in rows or word lines and in columns or bit lines. Each memory point includes or not an active cell 4. The cells 4 are formed of transistors or any other switching circuit likely to connect to a low voltage, currently the ground, the column including this cell. The addressing of cells 4 is performed by rows or word lines WL 6 connected to a line decoder 8. When an active cell is addressed, it modifies the voltage of the column 10 to which it is connected. In the case of a simple ROM, some cells are made inactive by construction, generally by suppressing of one of their connections, and the corresponding memory point never connects the corresponding column to ground, whatever the corresponding row voltage. Each column 10 is connected to a high supply voltage Vdd via a precharge transistor 12 and is connected to a first input 16 of a sense amplifier 18. Groups of columns may be associated by multiplexers (not shown). A second input 20 of each sense amplifier 18 is connected to a reference voltage Vref.

To read a memory point, column 10 is brought to a precharge voltage V_{pch} which is substantially equal to supply voltage V_{dd} and a high signal is applied on one of rows WL . If the memory point is not programmed, column 10 substantially 5 keeps the precharge voltage on its terminal 16. However, if the memory point is programmed, column 10 is discharged by a current I which flows through cell 4. The voltage on line 10 drops and sense amplifier 18 switches when the voltage on terminal 16 falls under reference voltage V_{ref} on terminal 20. The switching 10 time of amplifier 18 or read time is provided by the following relation:

$$T = C \cdot \Delta V / I$$

in which ΔV is potential difference $V_{pch}-V_{ref}$ between inputs 16 and 20 of sense amplifier 18, beyond which the switching of 15 sense amplifier 18 occurs, C represents the capacitance of column 10 and I represents the value of the current flowing through cell 4.

The respective values of capacitance C and of current I can be considered as constant. Thus, to reduce read time T , 20 voltage ΔV must be reduced, that is, a voltage V_{ref} as close as possible to V_{pch} must be chosen. Now, it is necessary to provide a security margin to take technological drifts, voltage offsets at the inputs of amplifier 18, fluctuations of voltages V_{dd} and V_{ref} , of low voltage V_{ss} , and of the difference between V_{dd} and 25 V_{pch} , into account.

A known solution to optimize the value of V_{ref} consists of performing a differential reading by adding to 30 memory 2 reference columns and by sampling a reference voltage on these reference columns. In practice, a relatively large number of reference columns must be provided, for example, one for eight real columns. This solution thus has the disadvantage of increasing the memory size and cost. Further, each reference column 21 introduces a stray capacitance.

An object of the present invention is to provide a method and a device for reading a ROM, overcoming the above disadvantages.

This object is achieved by means of a device for 5 reading a cell of a memory, including a differential sense amplifier having a first input terminal connected to a cell column and a circuit intended to provide to a second input terminal of the amplifier a reference voltage. The above-mentioned circuit includes a means for storing the voltage of 10 said column and a means for applying as a reference voltage the stored voltage modified by a predetermined amount.

According to an embodiment of the present invention, the presence of a cell translates as a reduction in the voltage of a column and the reference voltage is reduced by a predetermined amount with respect to the stored voltage. 15

According to an embodiment of the present invention, the above-mentioned circuit includes a first capacitive element intended to store the precharge voltage and a second capacitive element connectable in parallel on the first one to set the 20 value of the reference voltage.

According to an embodiment of the present invention, the capacitive elements are formed of the gate-source, gate-substrate, and gate-drain capacitances of MOS transistors.

The present invention also aims at a method for 25 reading a cell of a memory, including the steps of storing the voltage of a column just before reading; and modifying the stored voltage by a predetermined amount and using the modified voltage as a reference voltage.

According to an embodiment of the present invention, 30 this reading method further consists of comparing the reference voltage with a column voltage.

According to an embodiment of the present invention, this reading method further consists of applying the precharge voltage on a first capacitor; disconnecting the first capacitor

from the precharge voltage; and connecting in parallel on the first capacitor a second capacitor.

The foregoing objects, features and advantages of the present invention will be discussed in detail in the following 5 non-limiting description of specific embodiments in connection with the accompanying drawings.

Fig. 1, previously described, schematically and partially shows a ROM according to prior art;

Fig. 2 schematically shows a column of a ROM connected 10 to a reading device according to the present invention; and

Fig. 3 is a timing diagram illustrating the method for reading a ROM according to the present invention.

Fig. 2 illustrates a single column or bit line 10 of a ROM connected to a reading device according to the present 15 invention. Column 10 is associated with several cells 4 and is connected to a high supply voltage Vdd via a precharge transistor 12. The state of a cell 4 (programmed or unprogrammed) is read when row 6 corresponding to this cell is selected by line decoder 8. A terminal of column 10 is connected 20 to a first input 16 of a differential amplifier 18. A second input 20 of amplifier 18 is connected to a node 32 of a circuit 34 intended to provide a reference voltage Vref. Node 32 is connected to column 10 via a switch 36 controlled by binary 25 signal INT. Node 32 is connected to ground by a first capacitive element 38. Node 32 is connected to the first terminal of a second capacitive element 40, the second terminal of which can be connected to a first voltage V1 or to ground by a switch 42 controlled by a binary signal INJ.

Fig. 3 illustrates the operation of the reading device 30 according to the present invention. Curve 50 represents signal INT, curve 52 represents signal INJ, curve 54 represents the signal of word line WL, curve 56 represents the voltage of an unprogrammed memory point (no active cell), curve 57 represents the voltage of a programmed memory point (presence of an active

cell), and curve 58 represents reference voltage V_{ref} generated by circuit 34 at input 20 of amplifier 18.

Initially, column 10 is connected by means of precharge transistor 12 to supply voltage V_{dd} and takes a voltage V_{pch} close to voltage V_{dd} , which depends on the memory structure.

At a time t_1 at which a reading is desired to be performed, signal INT is switched from logic state "1" to logic state "0" to turn off switch 36 which was initially on. Node 32 then remains at the voltage of line 10.

At a time t_2 , binary signal INJ is switched from logic state "0" to logic state "1". This results in switching switch 42 and in connecting the second terminal of capacitive element 40 to ground (V_{ss}). The two capacitive elements then are in parallel and the distribution of the charge stored on capacitive elements 38 and 40 is modified. Calling C_1 , C_2 the values of the capacitances of capacitive elements 38, 40, and considering, for simplification, that V_{ss} is equal to 0:

- charge Q_1 initially stored on capacitive element 38 is equal to $C_1 V_{pch}$, charge Q_2 initially stored on capacitive element 40 is equal to $C_2 (V_{pch} - V_1)$; the total charge thus is $Q = (C_1 + C_2) V_{pch} - C_2 V_1$

- after turning on of switch 42, the charge on capacitors 38 and 40 and Q becomes equal to $(C_1 + C_2) V_{ref}$.

Thus, $V_{ref} = V_{pch} - V_1 C_2 / (C_1 + C_2)$.

It may for example be chosen to have $V_1 = V_{dd}$ or $V_1 = V_{pch}$ and the reference voltage will be a reduced voltage with respect to V_{pch} , for example, linked to V_{pch} by a constant coefficient equal to $C_1 / (C_1 + C_2)$. The reference voltage is thus defined in a very precise manner with respect to the precharge voltage on line 10. A reference voltage very close to the precharge voltage can thus be chosen. It should be noted that other subtractor or divider circuits may be provided by those skilled in the art to provide a reference voltage linked to a stored precharge voltage.

At a time t_3 , binary read signal WL is switched from logic state "0" to logic state "1". If the considered memory point is not programmed, the voltage of line 10 at point 16 remains at its initial precharge level, illustrated by curve 56, 5 or very slowly drops with respect to this level. If the considered memory point is programmed, column 10 discharges. At a time t_4 , the voltage of line 10, illustrated by curve 57, becomes smaller than V_{ref} and the reading is performed. Due to the fact that V_{ref} is only slightly smaller than V_{pch} , duration t_3-t_4 is 10 particularly short.

In an embodiment, the first and second capacitive elements 38, 40 may be NMOS transistor capacitances, for example, gate-substrate capacitances of transistors having their drain, their source, and their substrate connected to ground.

15 Those skilled in the art may provide various alternative to the present invention, provided that the storage of the voltage of a ROM column just before a reading and the use of a fraction of this voltage as a read reference voltage are provided. Further, although the present invention has been 20 described in relation with a memory for which the voltage of a column is likely to decrease, it will also apply to the case of a memory of which the voltage of a column is likely to increase. The reference voltage will then be increased with respect to the normal voltage of a column.

25 As an alternative, it should be noted that the mutual synchronizations of signals WL , INT , and INJ may be modified. Preferably, INJ will be delayed with respect to INT by an inverter. WL may be switched after, at the same time as, or little before INT .

30 Although the present invention has been described in the context of ROMs, it should be noted that it generally applies to any memory in which each cell is associated with a single read column.

35 In the described embodiment, the columns are associated with precharge transistors 12 with a common control.

Separate controls may be provided for each precharge transistor or for subsets of precharge transistors. This enables reducing the consumption for each reading.